

AzureWave AW-CU598 Wireless MCU with Bluetooth Low Energy Module Owner's Manual

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Product Information

Features

WLAN

- Support 1×1 dual-band 2.4 GHz/5 GHz Wi-Fi a/b/g/n/ac/ax radio
- 20 MHz channel operation
- Wi-Fi 6 Target Wake Time(TWT) support
- Wi-Fi 6 Extended Range (ER) and Dual Carrier Modulation (DCM)
- Power save features
- WPA2/WPAS3 personal and enterprise

Bluetooth

- Supports Bluetooth LE 5.3(Class 2) certified and Bluetooth LE 5.2 features supported
- Wi-Fi/Bluetooth coexistence protocol support
- Intelligent Adaptive Frequency Hopping (AFH)
- Bluetooth LE Privacy 1.2
- Bluetooth LE Long Range
- Bluetooth LE 2 Mbps
- Bluetooth LE Isochronous Channels
- Bluetooth LE Audio with integrated LC3 codec
- · Security: AES

Revision History

Document NO: R2-2598-DST-01

Version	Revision D ate	DCN NO.	Description	Initials	Approved
А	2023/02/04	DCN028668	Draft version	Roger Liu	N.C Chen
В	2023/06/27	DCN029399	Update block diagramUpdate pin table	Roger Liu	N.C Chen
С	2023/08/30	DCN029967	Modify feature and pin tableUpdate RF specification	Roger Liu	N.C Chen

Introduction

Product Overview

Azure Wave AW-CU598 is a highly integrated, low-power tri-radio Wireless RW610 MCU with an integrated MCU and Wi-Fi 6 + Bluetooth Low Energy (LE) 5.3 radios designed for a broad array of applications.

Applications include connected smart home devices, enterprise and industrial automation, smart accessories, and smart energy.

AW-CU598 includes a 260 MHz Arm Cortex-M33 core with Trust Zone-M, 1.2 MB on-chip SRAM and a Quad SPI interface with high bandwidth

AW-CU598 includes a full-featured 1×1 dual-band (2.4 GHz / 5 GHz) 20 MHz Wi-Fi 6 (802.11ax) subsystem bringing higher throughput, better network efficiency, lower latency, and improved range over previous generation Wi-Fi standards. The Bluetooth LE radio supports 2 Mbit/s high-speed data rate, long range and extended advertising as well as LE Audio for a better overall audio experience. In addition, **AW-CU598** can support Matter over Wi-Fi or Matter over Thread offering a common, interoperable application layer across ecosystems and products.

The advanced design of the **AW-CU598** delivers tight integration, low power, and highly secure operation in a space- and cost-efficient wireless MCU requiring only a single 3.3 V power supply

Block Diagram

TBD

Specifications Table

General

Features	Description
Product Description	IEEE 802.11 a/b/g/n/ac/ax Wi-Fi 6 with Bluetooth 5.3 Module
Major Chipset	NXP RW610 HVQFN(116 pins)
Host Interface	UART/JTAG
Dimension	28 mm x 15 mm x 2.39 mm
Package	LGA module, 88 pins
Antenna	u.FL Connector Receptacle ANT1 > WiFi à TX/RX Printed antenna ANT2 > WiFi à TX/RX
Weight	1.8 g

WLAN

Features	Description
WLAN Standar d	IEEE 802.11 a/b/g/n/ac/ax 1T1R
WLAN VID/PID	NA
WLAN SVID/SP ID	NA

Frequency Rag

2.4 GHz ISM Bands 2.412-2.472 GHz 5.15-5.25 GHz (FCC UNII-low band) for US/Canada and Europe5.25-5.35 GHz (FCC UNII-middle band) for US/Canada and Europe 5.47-5.725 GHz for Europe5.725-5.825 GHz (FCC UNII-high band) for US/Canada 5.825 GHz-5.895 GHz (FC C UNII-IV band) for US

2.4GHz:

- USA, NORTH AMERICA, Canada and Taiwan 1 ~ 11
- China, Australia, Most European Countries 1 ~ 13
- Japan,1~13

Modulation

5GHz:

- USA, Canada, Most European Countries –
 36,40,44,48,52,56,60,64,100,104,108,112,116,120,124,128,132,1
 36,140,149,153,157,161,165, 169, 173,177
- Japan –36,40,44,48,52,56,60,64,100,104,108,112,116,120,124,128,132,1 36,140
- China 36,40,44,48,52,56,60,64, 149,153,157,161,165

2.4G

	Min	Тур	Max	Unit
11b (11Mbps) @EVM<35%	16.5	18	19.5	dBm
11g (54Mbps) @EVM=-25 dB	14.5	16	17.5	dBm
11n (HT20 MCS7) @EVM=-2 7 dB	13.5	15	16.5	dBm
11ax(HE20 MCS11) @EVM= -35dB	12.5	14	15.5	dBm

Output Power

5G

	Min	Тур	Max	Unit
11a (54Mbps) @EVM=-25 d	14	16	18	dBm
1n (HT20 MCS7) @EVM=-27 dB	13	15	17	dBm
11ac(VHT20 MCS8) @EVMS -30 dB	12	14	16	dBm
11ax(HE20 MCS11) @EVMS -35 dB	11	13	15	dBm

	2.4G				
		Min	Тур	Max	Unit
	11b (11Mbps)	_	-86	-83	dBm
	11g (54Mbps)	_	-72	-69	dBm
	11n (HT20 MCS7)	_	-69	-66	dBm
	11ax (HE20 MCS11)	_	-63	-60	dBm
Receiver Sensit ivity	5G	,		'	
,		Min	Тур	Max	Unit
	11a (54Mbps)	_	-72	-69	dBm
	11n (HT20 MCS7)	_	-70	-67	dBm
	11ac(VHT20 MCS8)	_	-66	-63	dBm
	11ax(HE20 MCS11)	_	-65	-62	dBm
RatdiRa	WLAN: 802.11b: 1, 2, 5.5, 11Mbps 802.11a/g: 6, 9, 12, 18, 24, 802.11n: Maximum data ra 802.11ac: Maximum data r 802.11ax: Maximum data r WiFi: WPA2/WPA3 person	36, 48, 54Mbp tes up to 72 Mb ates up to 87 M ates up to 144 I	ps (20 MHz ch bps (20 MHz cl Mbps (20 MHz	hannel)	
Security	• WiFi: WPA2/WPAS3 pe • BT:AES	rsonal and ente	rprise and AES	CCMP/CMAC/	GCMP

Bluetooth

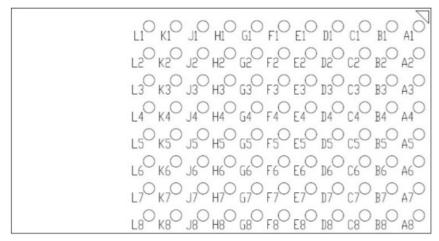
Features	Description					
Bluetooth Stand ard	Full Bluetooth 5.3 features					
Frequency Rage	2402MHz~2483.5MH	2402MHz~2483.5MHz				
Modulation	GFSK					
		Min	Тур	Max	Unit	
Output Power	Low Energy	0	2	4	dBm	
	BT Sensitivity ((PER<	(30.8%))				
Receiver Sensi		Min	Тур	Max	Unit	
tivity	Low Energy	_	-95	-92	dBm	
			·			

 $^{^{\}star}$ If you have any certification questions about output power please contact FAE directly. $\bf Operating\ Conditions$

Features	Description				
	Operating Conditions				
Voltage	3.3V +-5%				
Operating Temperature	-40°C ~ 85°C				
Operating Humidity	Less than 85% R.H.				
Storage Temperature	-40°C to +85°C				
Storage Humidity	Less than 60% R.H.				
ESD Protection					
Human Body Model	TBD				
Changed Device Model	TBD				

Pin Definition

Pin Map



AW-CU598 Pin Map (Top View)

Pin Table

Power

Pin N o	Definition	Basic Description	Voltage	Туре
A7	3.3V_IN_1	3.3V Power input	3.3V	Р
B7	3.3V_IN_2	3.3V Power input	3.3V	Р
K1	VIO_1	1.8V/3.3V Digital I/O Power Supply	1.8V/3.3V	Р
F1	VIO_2	1.8V/3.3V Digital I/O Power Supply	1.8V/3.3V	Р
A2	VIO_3	1.8V/3.3V Digital I/O Power Supply	1.8V/3.3V	Р
E1	VIO_4	1.8V/3.3V Digital I/O Power Supply	1.8V/3.3V	Р
B8	VIO_6	1.8V/3.3V Digital I/O Power Supply	1.8V/3.3V	Р

GPIO

Pin No	Definition	Basic Description	Voltage	Туре
A3	GPIO_22	GPIO[22]/AON_XTAL32K_IN/SLP_CLK_32K/ SCT0_PIN_INP2/ENET_RX_DATA0	VIO_3	I/O
A5	USB_DM	USB bus data-	3.3V	I/O
A6	USB_DP	USB bus data+	3.3V	I/O
B1	GPIO_24	GPIO[24]/AON_WAKEUP/CT1_MAT2/CT_INP6/ENET_TIMER 2/FC3_RXD_SDA_MOSI_DATA_USA RT/I2C/I2S/SPI	VIO_3	I/O
B2	GPIO_26	GPIO[26]/AON_CAPT/SCT0_OUT4/SCT0_PIN_INP4/ENET_TI MER3/FC3_TXD_SCL_MOSI_WS_USA RT/I2C/I2S/SPI	VIO_3	I/O
ВЗ	GPIO_23	GPIO[23]/AON_XTAL32K_OUT/SCT0_PIN_INP3/E NET_RX_ DATA1	VIO_3	I/O

	T			
B4	GPIO_25	GPIO[25]/AON_WAKEUP/CT1_MAT3/ CT_INP7/ ENET_CLK/FC3_SCK_USART/I2S/SPI	VIO_3	I/O
B5	USB_VBUS	VBUS selection, 5 V analog power supply	_	I/O
B6	USB_IDPIN	USB OTG ID pin	3.3V	I
C1	GPIO_28	QSPI flash slave select 0	VIO_4	I/O
C2	GPIO_31	Data bit 1 for QSPI flash	VIO_4	I/O
C3	GPIO_32	Data bit 2 for QSPI flash	VIO_4	I/O
C4	GPIO_29	QSPI flash data strobe input/output	VIO_4	I/O
C5	GPIO_27	GPIO[27]/AON_OUT/SCT0_OUT5/SCT0_PIN_INP5/ENET_TI MER0	VIO_3	I/O
C6	GPIO_4	GPIO[4]/Coexistence mode/SCT0_OUT1/SCT0_PIN_INP1/CL KIN_FRM_PD/ FC0_SCK_USART/I2S/SPI	VIO_6	I/O
C7	GPIO_3	GPIO[3]/SCT0_OUT0/SCT0_PIN_INP0/FC0_TXD_SCL_MIS O_WS_USART/I2C/I2S/SPI	VIO_6	I/O
C8	RESETn	Full Power-down (input) (active low) 0 = full power-down mode 1 = normal mode This pin has an internal pull high 51k ohm to 3.3V	3.3V	1
D1	GPIO_34	GPIO[34]/ QSPI_flash_CLK0/ SPIO0[2]	VIO_4	I/O
D2	GPIO_33	GPIO[33]/ QSPI_flash_D3/ SPIO0[2]	VIO_4	I/O
D3	GPIO_30	GPIO[30]/ QSPI_flash_D0	VIO_4	I/O
D7	GPIO_2	GPIO[2]/FC0_RXD_SDA_MOSI_DATA_USART/I2C/ I2S/SPI	VIO_6	I/O
D8	GPIO_49	GPIO[49]/LCD_D4/LCD SPI interface chip select/ADC0_7/ADC1_7/ACOMP7/SPIO0[17]	VIO_6	I/O
E7	GPIO_48	GPIO[48]/LCD 8080 interface read control /LCD SPI interface c lock/ADC0_6/ ADC1_6/ ACOMP6/ SPIO0[16]	VIO_6	I/O
E8	GPIO_47	GPIO[47]/LCD_D3 /LCD SPI interface data/ ADC0_5/ ACOMP 5/ SPIO0[15]	VIO_6	I/O
F2	GPIO_13	GPIO[13]/ CT_INP3/CT0_MAT3/ SWDIO/ FC2_RXD_SDA_MO SI_DATA_USART/I2C/I2S/SPI	VIO_2	I/O
F7	GPIO_46	GPIO[46]/ LCD_D2/LCD SPI interface data in_out/ADC0_4/ AC OMP4/ SPIO0[14]	VIO_6	I/O
F8	GPIO_45	GPIO[45]/LCD tearing effect inputsignal used to synchronize M CU frame writing/ LCD tearing effect input signalused to synchronize MCU frame writing/ ADC0_3/ACOMP3/EXT_VREF_ADC0_DAC/ SPIO0[13]	VIO_6	I/O
G1	GPIO_15	GPIO[15]/SD_CLK/UTICK_CAP0/UCLK/FC2_SCK_ USART/I 2S/SPI	VIO_2	I/O
G2	GPIO_16	GPIO[16]/SD_D3/UTICK_CAP1/URST/FC2_CTS_SDA_SSELN 0_USART/FC2_CTS_SDA_SSELN0_SP I/FC2_CTS_SDA_SSELN0_I2C_COPY	VIO_2	I/O

G7	GPIO_44	GPIO[44]/DAC_A/ADC0_2/ ACOMP2/output signal to reset the LCD device/SPIO0[12]	VIO_6	I/O
G8	GPIO_43	GPIO[43]/LCD_D1/ADC0_1/ACOMP1/DACB/SPIO0 [11]	VIO_6	I/O
H1	GPIO_17	GPIO[17]/SDIO_CMD/UTICK_CAP2/UIO/FC2_RTS_SCL_SSE LN1_USART/FC2_RTS_SCL_SSELN1_I 2C_COPY	VIO_2	I/O
H2	GPIO_18	GPIO[18]/SDIO_DAT2/UTICK_CAP3/UVS/ GPIO_INT_BMAT	VIO_2	I/O
H7	GPIO_42	GPIO[42]/ ADC0_0/ACOMP0/LCD_D0/SPIO0[10]	VIO_6	I/O
H8	GPIO_50	GPIO[50]/FREQME_GPIO_CLK/ADC_DAC_TRIGG ER0/ SPI O0[18]	VIO_6	I/O
J1	GPIO_19	GPIO[19]/SDIO_DAT0/FC3_RTS_SCL_SSELN1_U SART/ FC 3_RTS_SCL_SSELN1_I2C_COPY	VIO_2	I/O
J2	GPIO_20	GPIO[20]/SDIO_DAT1/FC3_CTS_SDA_SSELN0_U SART/SPI /_I2C_COPY	VIO_2	I/O
J3	RF_CNTL1	RF_CNTL1	3.3V	0
J4	RF_CNTL2	RF_CNTL2	3.3V	0
J5	RF_CNTL3	RF_CNTL3	3.3V	0
J7	EXT_FREQ	External radio frequency input signal (optional) -muxed with W CI-2_SOUT signal of WCI-2 interface.	1.8V	I
J8	EXT_PRI	External radio input priority signal (optional) Priority of the request from the external radio.	1.8V	I
K2	GPIO_14	GPIO[14]/ CT_INP4/CT1_MAT0/ SWCLK/ FC2_TXD_SCL_MISO_WS_USART/I2C/I2S/SPI	VIO_2	I/O
K3	GPIO_7	GPIO[7]/ JTAG_TMS/ FC1_SCK_USART/I2S/SPI	VIO_1	I/O
K4	GPIO_8	GPIO[8]/ JTAG_TDI/FC1_TXD_SCL_MISO_WS_USART/I2C/I2S/SPI	VIO_1	I/O
K5	GPIO_10	GPIO[10]/ JTAG_TRSTN/ FC1_RTS_SCL_SSELN1_USART	VIO_1	I/O
K7	EXT_GNT	External radio grant output signal	1.8V	0
K8	EXT_REQ	Request from external radio	1.8V	I
L2	GPIO_5	GPIO[5]/ MCLK/FC0_RTS_SCL_SSELN1_USART	VIO_1	I/O
L3	GPIO_6	GPIO[6]/ JTAG_TCK/ FC1_CTS_SDA_SSELN0_USART/SPI	VIO_1	I/O
L4	GPIO_9	GPIO[9]/ JTAG_TDO/ FC1_RXD_SDA_MOSI_DATA_USART/I 2C/I2S/SPI	VIO_1	I/O
L5	GPIO_11	GPIO[11]/ SCT0_OUT8:	VIO_1	I/O
L7	GPIO_12	GPIO[12]/UTMI_DRV_VBUS/CT0_MAT2/CT_INP2/ SD_HOST _INT	3.3V	I/O

Pin No	Definition	Basic Description	Voltage	Туре
A1	GND_A1	Ground	_	_
A4	GND_A4	Ground	_	_
A8	GND_A8	Ground	_	_
D4	GND_D4	Ground	_	_
D5	GND_D5	Ground	_	_
D6	GND_D6	Ground	_	_
E2	GND_E2	Ground	_	_
E3	GND_E3	Ground	_	_
E4	GND_E4	Ground	_	_
E5	GND_E5	Ground	_	_
E6	GND_E6	Ground	_	_
F3	GND_F3	Ground	_	_
F4	GND_F4	Ground	_	_
F5	GND_F5	Ground	_	_
F6	GND_F6	Ground	_	_
G3	GND_G3	Ground	_	_
G4	GND_G4	Ground	_	_
G5	GND_G5	Ground	_	_
G6	GND_G6	Ground	_	_
H3	GND_H3	Ground	_	_
H4	GND_H4	Ground	_	_
H5	GND_H5	Ground	_	_
H6	GND_H6	Ground	_	_
J6	GND_J6	Ground	_	_
K6	GND_K6	Ground	_	_
L1	GND_L1	Ground	_	_
L6	GND_L6	Ground	_	_
L8	GND_L8	Ground	_	_

Electrical Characteristics

Absolute Maximum Ratings

Symbol	Parameter	Minimum	Typical	Maximum	Unit
VBAT	DC supply for the3.3V in put	_	3.3	3.96	V
VIO	1.8 V/3.3 V digital I/O po	_	1.8	2.16	V
VIO	wer supply		3.3	3.96	V

Recommended Operating Conditions

Symbol	Parameter	Minimum	Typical	Maximum	Unit
VBAT	DC supply for the3.3V in put	3.14	3.3	3.46	V
VIO	1.8 V/3.3 V digital I/O po	1.71	1.8	1.89	V
VIO	wer supply	3.14	3.3	3.46	V

Digital 10 Pin DC Characteristics

VIO 1.8V Operation

Symbol	Parameter	Minimum	Typical	Maximum	Unit
VIO	I/O pad supply voltage	1.71	1.8	1.89	V
VIH	Input high voltage	0.7*VIO	_	VIO+0.4	V
VIL	Input low voltage	-0.4	_	0.3*VIO	V
VHYS	Input Hysteresis	100	_	_	mV

VIO 3.3V Operation

Symbol	Parameter	Minimum	Typical	Maximum	Unit
VIO	I/O pad supply voltage	3.14	3.3	3.46	V
VIH	Input high voltage	0.7*VIO	_	VIO+0.4	V
VIL	Input low voltage	-0.4	_	0.3*VIO	V
VHYS	Input Hysteresis	100	_	_	mV

Power Consumption

Power Supply=3.3V					
MCU Status	WiFi Deep Sleep	WiFi STA Connected	WiFi IEEE Power S aving	WiFi Power Down	
	200Mhz	200Mhz	200Mhz	200Mhz	
PM0(Active)	TBD				
PM1(Idle)					
PM2(Standby)					
PM3(Sleep)					
PM4(Shutdown)					

Current Unit: mA

- (1) The MCU gets its clock from the WiFi subsection. When WiFi is powered down, the MCU is forced to run off of the internal RC32M clock. NXP does not recommend this and hence this mode is not supported. Customers can instead put the WiFi in Deep Sleep to save power.
- CURRENT consumption (MFG WLAN TX /RX)

Item					Power Supply=3.3V		
Band (Mode	BW (MHz)	RF Power (Tran	smit	Rec	eive
GHz)	Wiode	DVV (IVITIZ)	dBm)	Max.	Avg.	Max.	Avg.
	11b@1M	20	17	TBD			
2.4	11b@11M	20	17				
2.4	11g@54M	20	14				
	11n@MCS7	20	13				

*Current Unit: mA

Note: DUT set Adjust Packet gap with Sifs. Ext: Enter option: 35 1 1

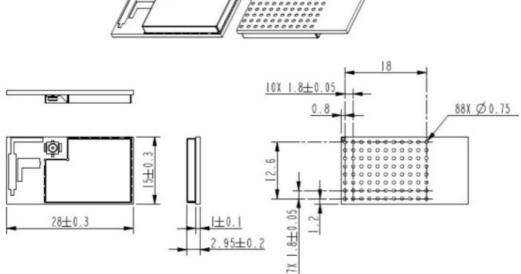
External 32.768KHZ Crystal Requirement

An external 32.768kHz crystal can be used for low-power consumption. Below are the specifications for this crystal.

Parameter	Min	Тур	Max	Unit
Output frequency	_	32.768	_	kHz
Frequency accuracy(Over process, voltage, t emperature (PVT))	_	_	-22/-192	PPM
Temperature tolerance(From -40°C to 120°C)	_	0.0192	_	%
Start-up time(From power on to CLK_RDY w ithout noise injection)	_	208	380	ms
Start-up time(From power on to CLK_RDY w ith noise injection)	_	15	170	ms
Duty cycle	46.7	47.4	49.77	%
Crystal ESR resistance		50	80	kΩ

Mechanical Information

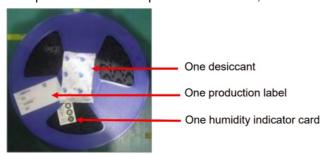




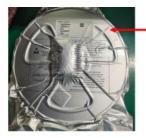
TOLERANCE UNLESS OTHERWISE SPECIFIED:± 0.1mm

Packing Information

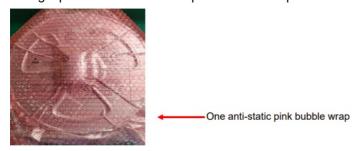
- 1. One reel can pack 3,000pcs modules
- 2. One production label is pasted on the reel, one desiccant and one humidity indicator card are put on the reel



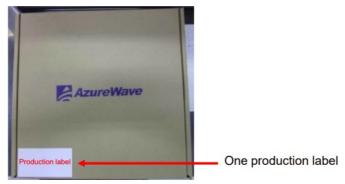
3. One reel is put into the anti-static moisture barrier bag, and then one label is pasted on the bag



4. A bagis put into the anti-static pink bubble wrap



5. A bubble wrap is put into the inner box and then one label is pasted on the inner box



6. 3 inner boxes could be put into one carton



7. Sealing the carton by AzureWave tape



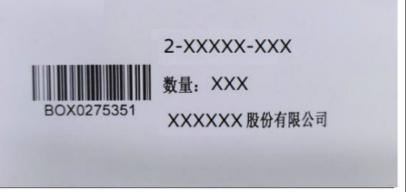
8. One carton label and one box label are pasted on the carton. If one carton is not full, one balance label pasted

on the carton



		AzureWave AzureWave Technologies, Inc.
	Azure Wave PIN	2-XXXXX-XXX
	Customer	
	Customer P/N	
	Customer P/0	
Example of carton label	Description	ZAE-XXXXX-XXX
	Q'ty	IVRIATKffil4tetk
	C/N	
	N.W.	G.W.
	RoHS TE	Made in China

Example of box label





Note:

- 1 reel = 1 inner box = 1,000pcs
- 1 carton = 3 inner boxes = 3* 1,000pcs = 3,000pcs

FCC:

Federal Communication Commission Interference Statement

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

IMPORTANT NOTE:

This module is intended for OEM integrator. This module is only FCC authorized for the specific rule parts listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. The final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

Additional testing and certification may be necessary when multiple modules are used.

OEM integrators that they must use the equivalent antennas or C2PC will be required.

This equipment complies with FCC mobile radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20cm between the radiator & your body. If the module is installed in a portable host, a separate SAR evaluation is required to confirm compliance with relevant FCC portable RF exposure rules.

The host manufacturer should reference KDB Publication 996369 D04 Module Integration Guide.

USERS MANUAL OF THE END PRODUCT:

In the users manual of the end product, the end user has to be informed to keep at least 20cm separation with the antenna while this end product is installed and operated. The end user has to be informed that the FCC radio-frequency exposure guidelines for an uncontrolled environment can be satisfied.

The end user has to also be informed that any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment.

This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC regulations restrict the operation of this device to indoor use only. This device cannot operate as a subordinate between separate buildings or structures.

FORM NO.: FR2-015 A

LABEL OF THE END PRODUCT:

The final end product must be labeled in a visible area with the following "Contains

TXFCC ID: TLZ-CU5XX".

This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC regulations restrict the operation of this device to indoor use only.

NCC:

For low-power radio frequency equipment that has obtained a certification, companies, businesses or users may not change the frequency, increase the power or alter the original design characteristics and functions without approval. The use of low-power radio frequency equipment must not affect flight safety or interfere with legal communications; if interference is found, it should be immediately discontinued and can only be used again after improvement to eliminate interference.

The aforementioned legal communications refer to radio communications that operate in accordance with the provisions of the Telecommunications Management Act. Low-power radio frequency devices must tolerate interference from legal communications or industrial, scientific and medical radio wave radiating electrical equipment.

Avoid affecting the operation of nearby radar systems.

After obtaining the certification, the module will be labeled with the inspection certificate in accordance with the regulations, and the platform manufacturer is required to mark "This product contains RF module CCXX xx LP yyy Z z" on the platform.

Ant list

Ant.	Port	Brand	Model Name	Antenna Type	Connector	Gain (dBi)
1	1	ARISTOTLE	RFA-27-C38H1-C198	Dipole Antenna	u.FL	
2	1	Molex	2128600011	Dipole Antenna	u.FL	Note1
3	1	LYN wave	2570	PCB Antenna	N/A	

Note 1:

Ant.	Gain (dBi)			
AIII.	WLAN 2.4GHz/Bluetooth/Thread	WLAN 5GHz		
1	3	5		
2	5.3	4.5		
3	2.2	4.4		

The antenna is limited as the antenna listed.

FORM NO.: FR2-015_A



Documents / Resources



References

User Manual

Manuals+, Privacy Policy

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